



M83C Component Top Mark Change for eUSB SSD Module.

PCN: 33234

Published: 2019-04-08

Type: BOM Revision, Product Mark/label Change

Description: Visual Change only. Top Mark Change on NAND memory component used in the assembly of the following eUSB's:

Current Component Mark / FBGA Code:

MT29F32G08ABCDBJ4-6IT:D NW772

MT29F64G08AECDBJ4-6IT:D NW879

New Component Mark / FBGA Code:

MT29F32G08ABCDBJ4-6ITR:D NW904

MT29F64G08AECDBJ4-6ITR:D NW905

Component fit and function is the same, no change to the eUSB functionality.

Sample availability upon request.

Reason: Supply Flexibility/Security

Product Affected: M83C eUSB SSD Modules

Affected Micron Part Number Module	Recommended Replacement	Customer Part Number
MTEDFAE004SCA-1P2		
MTEDFAE004SCA-1P2IT		557-2034-ND
MTEDFAE008SCA-1P2		
MTEDFAE008SCA-1P2IT		
MTEDFAE016SCA-1P2IT		
MTEDFBR004SCA-1P2IT		557-2035-ND
MTEDFBR008SCA-1P2IT		557-2036-ND
MTEDFBR016SCA-1P2IT		

*Materials that have been ordered are in **bold**.

Method of Identification: Top Mark Change

Micron Sites Affected: All Sites

Product Ship Date: 2019-07-07

NOTE: Per JEDEC Standard JESD46-C Section 3.2.3; lack of acknowledgment of this PCN within 30 days constitutes acceptance of change.

Micron Confidential and Proprietary Information

Attachments

There are no attachments on this PCN